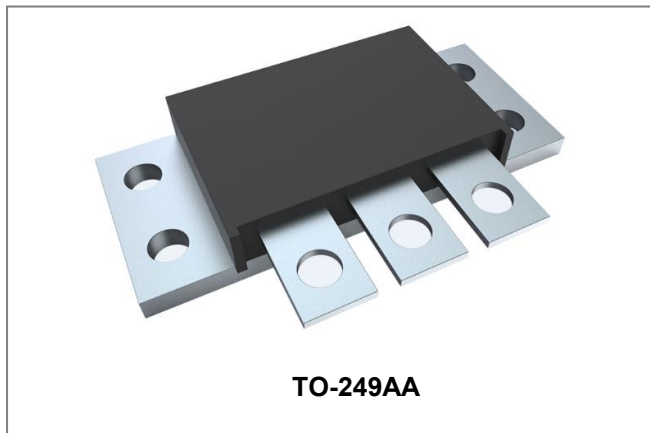


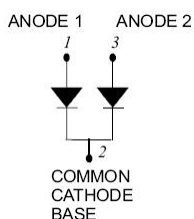
169CMQ135/169CMQ150 SCHOTTKY RECTIFIER



Features

- 150°C T_J operation
- Isolated heatsink
- Low profile, high current package
- Center tap module
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Baseplate: Nickel plated; Terminals: Nickel plated
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Schematic & Pin Configuration



Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

Maximum Ratings:

| Characteristics | Symbol | Condition | Max. | | Units |
|---|--------------------|--|--------------------------------|-----------|-------|
| | | | 135 | 169CMQ135 | |
| Peak Repetitive Reverse Voltage | V _{RRM} | - | 135 | 169CMQ135 | V |
| Working Peak Reverse Voltage | V _{RWM} | | 150 | 169CMQ150 | |
| DC Blocking Voltage | V _R | | | | |
| Average Rectified Forward Current | I _{F(AV)} | 50% duty cycle @T _c =87°C, rectangular wave form | 80(Per Leg) 160(Per Device) | | A |
| Peak One Cycle Non-Repetitive Surge Current | I _{FSM} | 8.3 ms, half Sine pulse | 960 | | A |

Electrical Characteristics:

| Characteristics | Symbol | Condition | Typ. | Max. | Units |
|--------------------------------|-----------------|---|--------|--------|-------|
| Forward Voltage Drop(Peg Leg)* | V _{F1} | @ 80A, Pulse, T _J = 25 °C | 0.81 | 1.05 | V |
| | V _{F2} | @ 80A, Pulse, T _J = 125 °C | 0.70 | 0.85 | V |
| Reverse Current(Peg Leg)* | I _{R1} | @V _R = rated V _R , T _J = 25 °C | 0.0002 | 1.5 | mA |
| | I _{R2} | @V _R = rated V _R , T _J = 125 °C | 0.4 | 21 | mA |
| Junction Capacitance(Peg Leg) | C _T | @V _R = 5V, T _C = 25 °C f _{SIG} = 1MHz | 1150 | 1300 | pF |
| Voltage Rate of Change | dv/dt | - | - | 10,000 | V/μs |

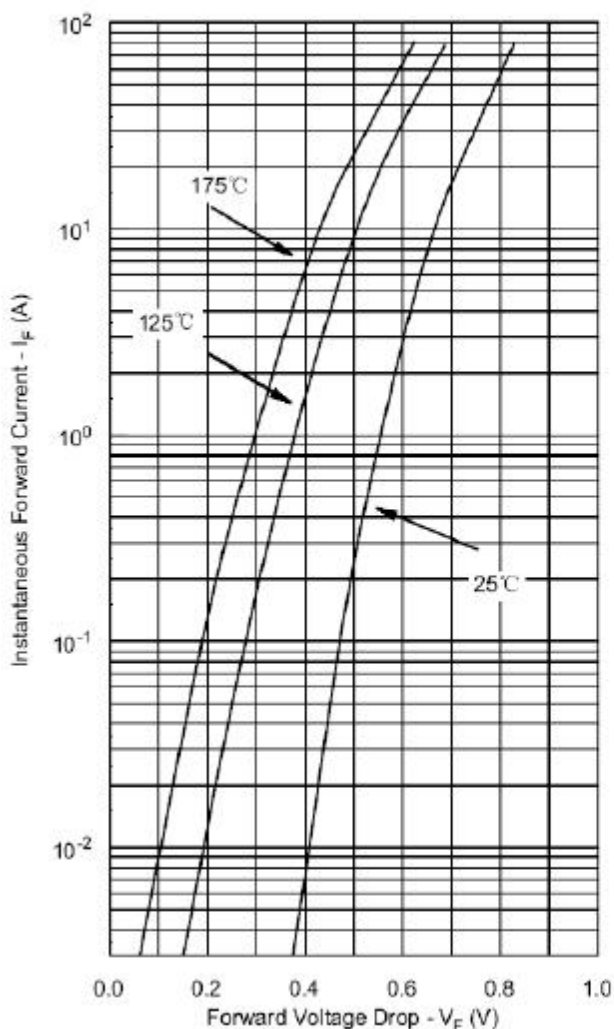
* Pulse width < 300 μs, duty cycle < 2%

Thermal-Mechanical Specifications:

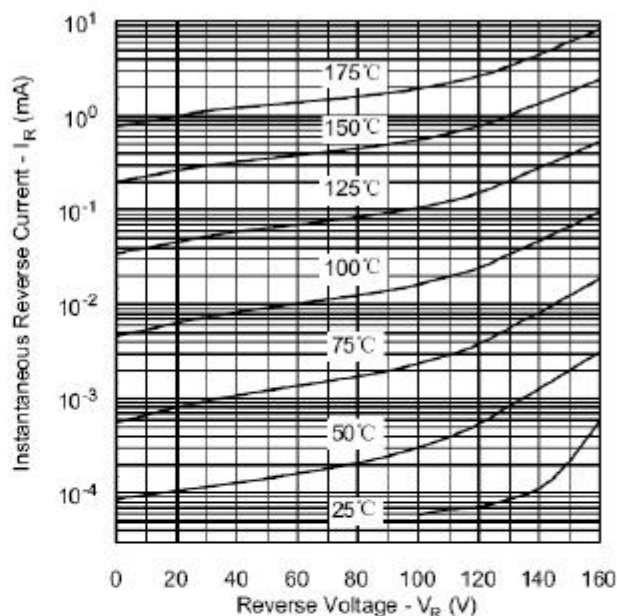
| Characteristics | Symbol | Condition | Specification | Units |
|---|------------------|---|---------------|-------|
| Junction Temperature | T _J | - | -55 to +150 | °C |
| Storage Temperature | T _{stg} | - | -55 to +150 | °C |
| Typical Thermal Resistance Junction to Case (Per Leg) | R _{θJC} | DC operation | 1.0 | °C/W |
| Typical Thermal Resistance Junction to Case (Per Package) | R _{θJC} | DC operation | 0.50 | °C/W |
| Typical Thermal Resistance, case to Heat Sink | R _{θcs} | Mounting surface, smooth and greased | 0.10 | °C/W |
| Mounting Torque | T _M | - | 40(min) | Kg-cm |
| | | | 58(max) | |
| Approximate Weight | wt | - | 58 | g |

Ratings and Characteristics Curves

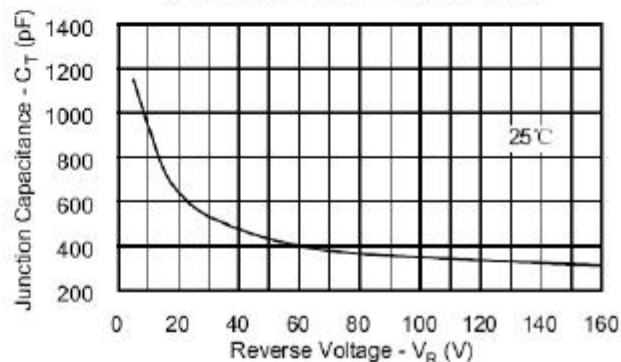
Typical Forward Characteristics



Typical Reverse Characteristics



Typical Junction Capacitance

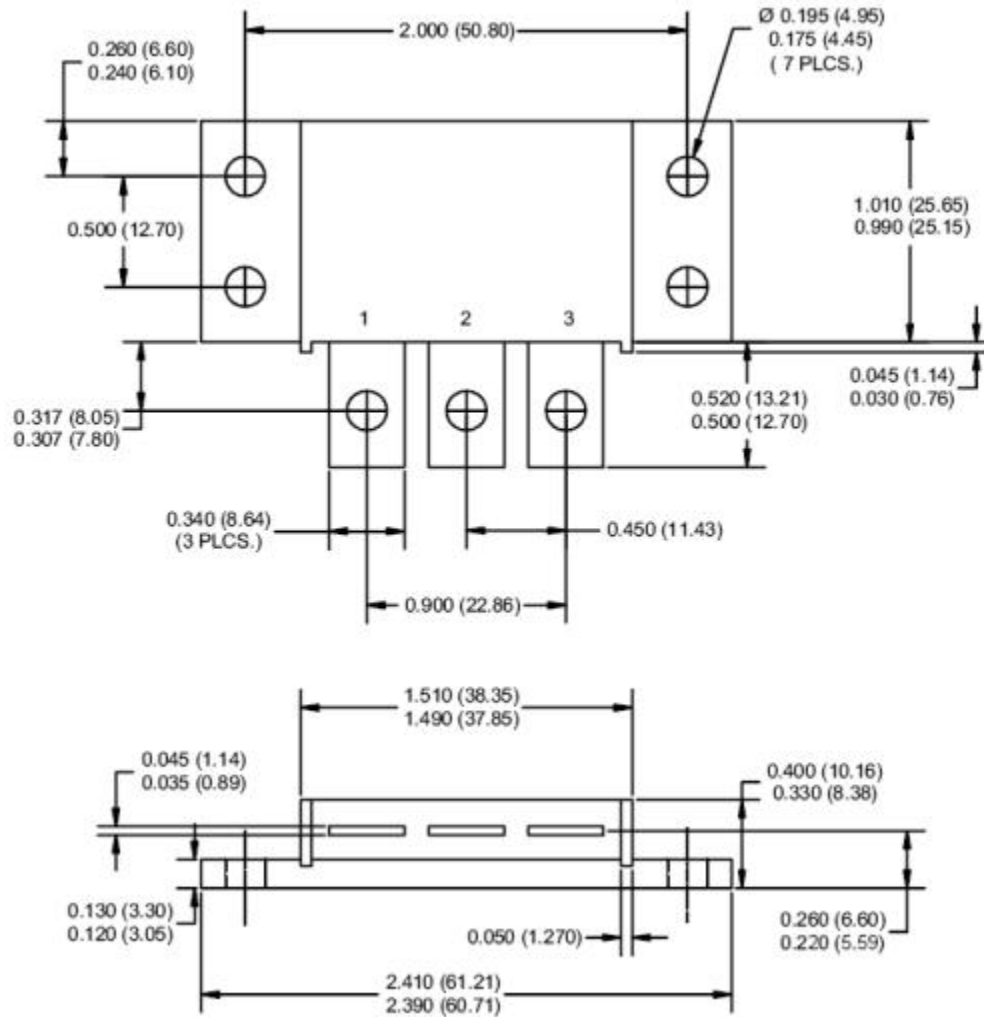


Ordering Information

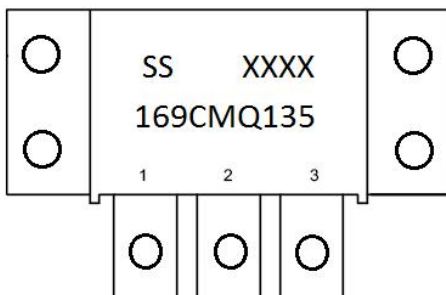
| Device | Package | Shipping |
|---------------|-------------------|------------|
| 169CMQ SERIES | TO-249AA(Pb-Free) | 24pcs/ box |

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Mechanical Dimensions TO-249AA (Inches/Millimeters)



Marking Diagram



Where XXXX is YYWW

1st row SS YYWW
2nd row 169CMQ135
3rd row 1 2 3 (pin)
SS = SS
YY = Year
WW = Week

Cautions: Molding resin
Epoxy resin UL:94V-0

DISCLAIMER:

1- The information given herein, including the specifications and dimensions, is subject to change without prior notice to improve product characteristics. Before ordering, purchasers are advised to contact the SMC Diode Solutions sales department for the latest version of the datasheet(s).

2- In cases where extremely high reliability is required (such as use in nuclear power control, aerospace and aviation, traffic equipment, medical equipment, and safety equipment), safety should be ensured by using semiconductor devices that feature assured safety or by means of users' fail-safe precautions or other arrangement.

3- In no event shall SMC Diode Solutions be liable for any damages that may result from an accident or any other cause during operation of the user's units according to the datasheet(s). SMC Diode Solution assumes no responsibility for any intellectual property claims or any other problems that may result from applications of information, products or circuits described in the datasheets.

4- In no event shall SMC Diode Solutions be liable for any failure in a semiconductor device or any secondary damage resulting from use at a value exceeding the absolute maximum rating.

5- No license is granted by the datasheet(s) under any patents or other rights of any third party or SMC Diode Solutions.

6- The datasheet(s) may not be reproduced or duplicated, in any form, in whole or part, without the expressed written permission of SMC Diode Solutions.

7- The products (technologies) described in the datasheet(s) are not to be provided to any party whose purpose in their application will hinder maintenance of international peace and safety nor are they to be applied to that purpose by their direct purchasers or any third party. When exporting these products (technologies), the necessary procedures are to be taken in accordance with related laws and regulations..